

1A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

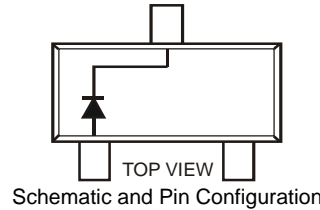
- Very Low Forward Voltage Drop
- High Conductance
- For Use in DC-DC Converter, PCMCIA, and Mobile Telecommunications Applications
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 and 2)**
- **Halogen and Antimony Free. "Green" Device(Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 e3
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)



Top View



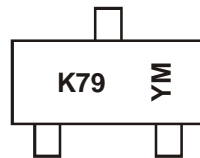
Schematic and Pin Configuration

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
BAT1000-7-F	AEC-Q101	SOT23	3000/Tape & Reel
BAT1000Q-7-F	Automotive	SOT23	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



K79 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: A = 2013)
 M = Month (ex: 9 = September)

Date Code Key

Year	2002	2003	2004	2010	2011	2012	2013	2014	2015	2016
Code	N	P	R	X	Y	Z	A	B	C	D

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Current	I _O	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load	I _{FSM}	5.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	500	mW
Typical Thermal Resistance, Junction to Ambient Air (Note 6)	R _{θJA}	200	°C/W
Operating Temperature Range	T _J	-40 to +125	°C
Storage Temperature Range	T _{STG}	-40 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	40	—	—	V	I _R = 300μA
Forward Voltage	V _F	—	225	270	mV	I _F = 50mA
			235	290		I _F = 100mA
			290	340		I _F = 250mA
			340	400		I _F = 500mA
			390	450		I _F = 750mA
			420	500		I _F = 1000mA
475	600	I _F = 1500mA				
Reverse Current (Note 7)	I _R	—	—	100	μA	V _R = 30V
Total Capacitance	C _T	—	175	—	pF	V _R = 0V, f = 1.0MHz
			25	—	pF	V _R = 25V, f = 1.0MHz

Notes: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
7. Short duration pulse test used to minimize self-heating effect.

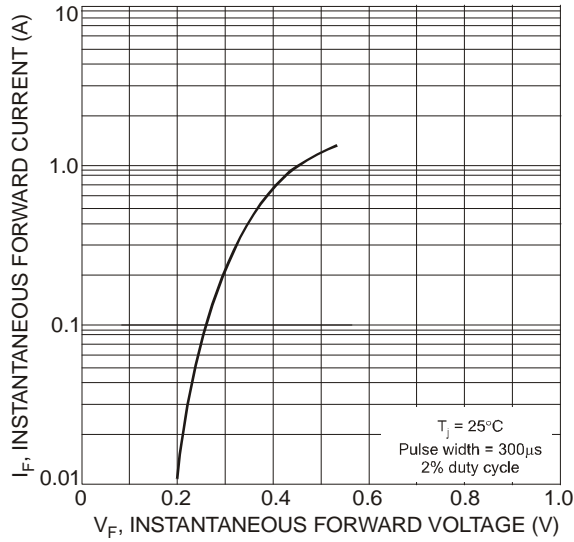


Fig. 1 Typical Forward Characteristics

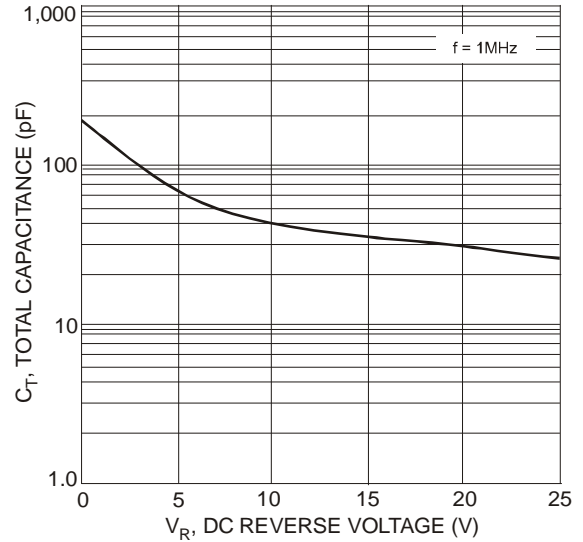


Fig. 2 Total Capacitance vs. Reverse Voltage

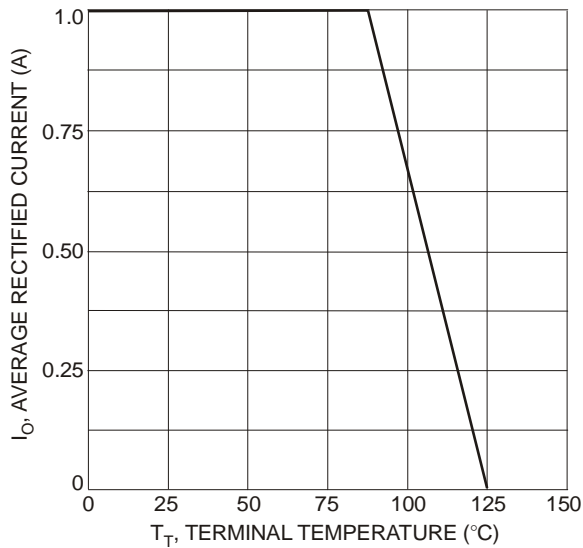


Fig. 3 Forward Current Derating Curve

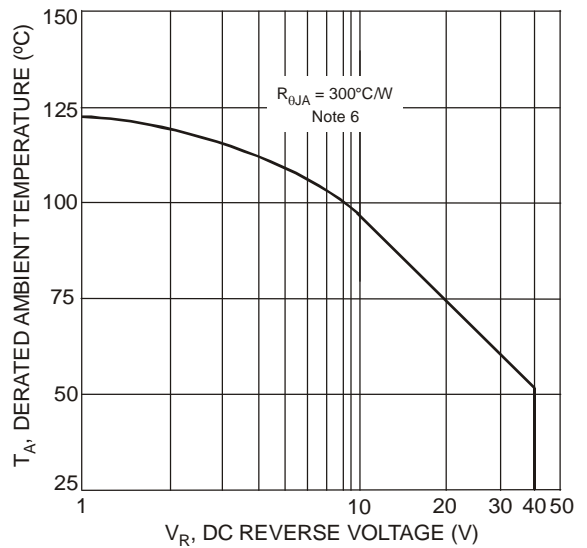
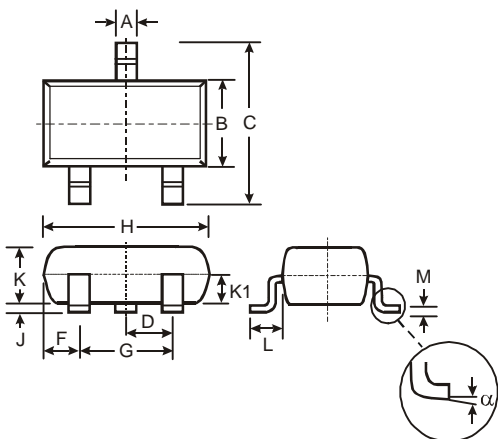


Fig. 4 Operating Temperature Derating

Note: 8. Assumed application thermal conditions. $R_{\theta JA}$ varies depending on application.

Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

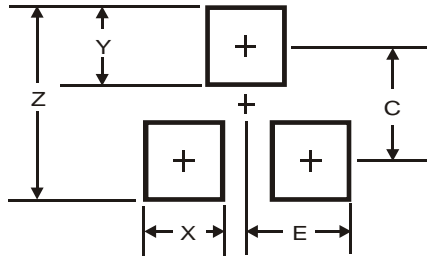


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-

All Dimensions in mm

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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